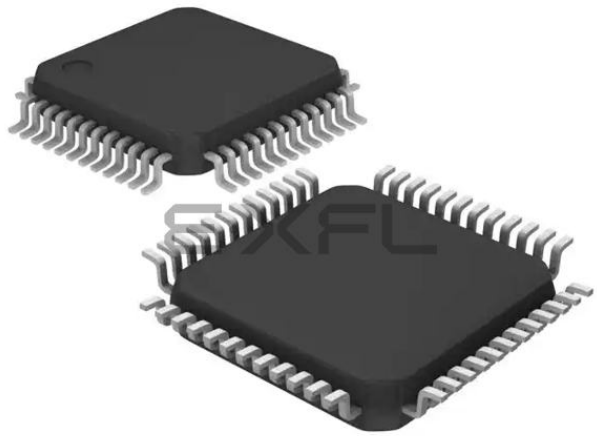

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Details	
Product Status	Active
Core Processor	12V1
Core Size	16-Bit
Speed	25MHz
Connectivity	CANbus, IrDA, LINbus, SCI, SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	40
Program Memory Size	96KB (96K x 8)
Program Memory Type	FLASH
EEPROM Size	3K x 8
RAM Size	8K x 8
Voltage - Supply (Vcc/Vdd)	3.13V ~ 5.5V
Data Converters	A/D 12x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/nxp-semiconductors/s9s12g96f0vlf

Chapter 6
Interrupt Module (S12SINTV1)

Chapter 7
Background Debug Module (S12SBDMV1)

Table 1-21. 64-Pin LQFP Pinout for S12G96 and S12G128

	Function <----lowest-----PRIORITY-----highest---->					Power Supply	Internal Pull Resistor	
Package Pin	Pin	2nd Func.	3rd Func.	4th Func	5th Func		CTRL	Reset State
1	PJ6	KWJ6	SCK2	—	—	V_{DDX}	PERJ/PPSJ	Up
2	PJ5	KWJ5	MOSI2	—	—	V_{DDX}	PERJ/PPSJ	Up
3	PJ4	KWJ4	MISO2	—	—	V_{DDX}	PERJ/PPSJ	Up
4	RESET	—	—	—	—	V_{DDX}	PULLUP	
5	VDDX	—	—	—	—	—	—	—
6	VDDR	—	—	—	—	—	—	—
7	VSSX	—	—	—	—	—	—	—
8	PE0[1]	EXTAL	—	—	—	V_{DDX}	PUCR/PDPEE	Down
9	VSS	—	—	—	—	—	—	—
10	PE1[1]	XTAL	—	—	—	V_{DDX}	PUCR/PDPEE	Down
11	TEST	—	—	—	—	N.A.	$\overline{\text{RESET}}$ pin	Down
12	PJ0	KWJ0	MISO1	—	—	V_{DDX}	PERJ/PPSJ	Up
13	PJ1	KWJ1	MOSI1	—	—	V_{DDX}	PERJ/PPSJ	Up
14	PJ2	KWJ2	SCK1	—	—	V_{DDX}	PERJ/PPSJ	Up
15	PJ3	KWJ3	$\overline{\text{SS1}}$	—	—	V_{DDX}	PERJ/PPSJ	Up
16	BKGD	MODC	—	—	—	V_{DDX}	PUCR/BKPUE	Up
17	PP0	KWP0	ETRIG0	API_EXTCLK	PWM0	V_{DDX}	PERP/PPSP	Disabled
18	PP1	KWP1	ETRIG1	ECLKX2	PWM1	V_{DDX}	PERP/PPSP	Disabled
19	PP2	KWP2	ETRIG2	PWM2	—	V_{DDX}	PERP/PPSP	Disabled
20	PP3	KWP3	ETRIG3	PWM3	—	V_{DDX}	PERP/PPSP	Disabled
21	PP4	KWP4	PWM4	—	—	V_{DDX}	PERP/PPSP	Disabled
22	PP5	KWP5	PWM5	—	—	V_{DDX}	PERP/PPSP	Disabled
23	PP6	KWP6	PWM6	—	—	V_{DDX}	PERP/PPSP	Disabled
24	PP7	KWP7	PWM7	—	—	V_{DDX}	PERP/PPSP	Disabled
25	PT7	IOC7	—	—	—	V_{DDX}	PERT/PPST	Disabled
26	PT6	IOC6	—	—	—	V_{DDX}	PERT/PPST	Disabled
27	PT5	IOC5	—	—	—	V_{DDX}	PERT/PPST	Disabled

Table 1-31. 100-Pin LQFP Pinout for S12GA192 and S12GA240

	Function <----lowest-----PRIORITY-----highest---->				Power Supply	Internal Pull Resistor	
Package Pin	Pin	2nd Func.	3rd Func.	4th Func.		CTRL	Reset State
86	PS4	MISO0	—	—	V_{DDX}	PERS/PPSS	Up
87	PS5	MOSI0	—	—	V_{DDX}	PERS/PPSS	Up
88	PS6	SCK0	—	—	V_{DDX}	PERS/PPSS	Up
89	PS7	API_EXTCLK	$\overline{SS0}$	—	V_{DDX}	PERS/PPSS	Up
90	VSSX2	—	—	—	—	—	—
91	VDDX2	—	—	—	—	—	—
92	PM0	RXCAN	—	—	V_{DDX}	PERM/PPSM	Disabled
93	PM1	TXCAN	—	—	V_{DDX}	PERM/PPSM	Disabled
94	PD4	—	—	—	V_{DDX}	PUCR/PUPDE	Disabled
95	PD5	—	—	—	V_{DDX}	PUCR/PUPDE	Disabled
96	PD6	—	—	—	V_{DDX}	PUCR/PUPDE	Disabled
97	PD7	—	—	—	V_{DDX}	PUCR/PUPDE	Disabled
98	PM2	RXD2	—	—	V_{DDX}	PERM/PPSM	Disabled
99	PM3	TXD2	—	—	V_{DDX}	PERM/PPSM	Disabled
100	PJ7	KWJ7	$\overline{SS2}$	—	V_{DDX}	PERJ/PPSJ	Up

[1] The regular I/O characteristics (see Section A.2, “I/O Characteristics”) apply if the EXTAL/XTAL function is disabled

2.4.3.36 Port P Data Direction Register (DDRP)

Address 0x025A (G1, G2) Access: User read/write[1]

	7	6	5	4	3	2	1	0
R W	DDRP7	DDRP6	DDRP5	DDRP4	DDRP3	DDRP2	DDRP1	DDRP0
Reset	0	0	0	0	0	0	0	0

Address 0x025A (G3) Access: User read/write[1]

	7	6	5	4	3	2	1	0
R	0	0	DDRP5	DDRP4	DDRP3	DDRP2	DDRP1	DDRP0
W								
Reset	0	0	0	0	0	0	0	0

Figure 2-37. Port P Data Direction Register (DDRP)

[1] Read: Anytime
Write: Anytime

Table 2-63. DDRP Register Field Descriptions

Field	Description
7-0 DDRP	**Port P data direction—** This bit determines whether the associated pin is an input or output. 1 Associated pin configured as output 0 Associated pin configured as input

2.4.3.37 Port P Pull Device Enable Register (PERP)

Address 0x025C (G1, G2) Access: User read/write[1]

	7	6	5	4	3	2	1	0
R W	PERP7	PERP6	PERP5	PERP4	PERP3	PERP2	PERP1	PERP0
Reset	0	0	0	0	0	0	0	0

Address 0x025C (G3) Access: User read/write[1]

	7	6	5	4	3	2	1	0
R	0	0	PERP5	PERP4	PERP3	PERP2	PERP1	PERP0
W								
Reset	0	0	0	0	0	0	0	0

Figure 2-38. Port P Pull Device Enable Register (PERP)

[1] Read: Anytime
Write: Anytime

2.4.3.43 Port J Input Register (PTIJ)

Address 0x0269 (G1, G2) Access: User read only[1]

	7	6	5	4	3	2	1	0
R	PTIJ7	PTIJ6	PTIJ5	PTIJ4	PTIJ3	PTIJ2	PTIJ1	PTIJ0
W								
Reset	0	0	0	0	0	0	0	0

Address 0x0269 (G3) Access: User read only[1]

	7	6	5	4	3	2	1	0
R	0	0	0	0	PTIJ3	PTIJ2	PTIJ1	PTIJ0
W								
Reset	0	0	0	0	0	0	0	0

Figure 2-43. Port J Input Register (PTIJ)

[1] Read: Anytime
Write:Never

Table 2-69. PTIJ Register Field Descriptions

Field	Description
7-0 PTIJ	**Port J input data—** A read always returns the buffered input state of the associated pin. It can be used to detect overload or short circuit conditions on output pins.

2.4.3.44 Port J Data Direction Register (DDRJ)

Address 0x026A (G1, G2) Access: User read/write[1]

	7	6	5	4	3	2	1	0
R W	DDRJ7	DDRJ6	DDRJ5	DDRJ4	DDRJ3	DDRJ2	DDRJ1	DDRJ0
Reset	0	0	0	0	0	0	0	0

Address 0x026A (G3) Access: User read/write[1]

	7	6	5	4	3	2	1	0
R	0	0	0	0	DDRJ3	DDRJ2	DDRJ1	DDRJ0
W								
Reset	0	0	0	0	0	0	0	0

Figure 2-44. Port J Data Direction Register (DDRJ)

[1] Read: Anytime
Write: Anytime

2.5 PIM Ports - Functional Description

2.5.1 General

Each pin except BKGD can act as general-purpose I/O. In addition most pins can act as an output or input of a peripheral module.

2.5.2 Registers

A set of configuration registers is common to all ports with exception of the ADC port (Table 2-91). All registers can be written at any time, however a specific configuration might not become active.

Example: Selecting a pullup device. This device does not become active while the port is used as a push-pull output.

Table 2-91. Register availability per port[1]

Port	Data (Portx, PTx)	Input (PTIx)	Data Direction (DDRx)	Pull Enable (PERx)	Polarity Select (PPSx)	Wired-Or Mode (WOMx)	Interrupt Enable (PIEx)	Interrupt Flag (PIFx)
A	yes	-	yes	yes	-	-	-	-
B	yes	-	yes		-	-	-	-
C	yes	-	yes		-	-	-	-
D	yes	-	yes		-	-	-	-
E	yes	-	yes		-	-	-	-
T	yes	yes	yes	yes	yes	-	-	-
S	yes	yes	yes	yes	yes	yes	-	-
M	yes	yes	yes	yes	yes	yes	-	-
P	yes	yes	yes	yes	yes	-	yes	yes
J	yes	yes	yes	yes	yes	-	yes	yes
AD	yes	yes	yes	yes	yes	-	yes	yes

[1] Each cell represents one register with individual configuration bits

2.5.2.1 Data Register (PORTx, PTx)

This register holds the value driven out to the pin if the pin is used as a general-purpose I/O.

Writing to this register has only an effect on the pin if the pin is used as general-purpose output. When reading this address, the buffered state of the pin is returned if the associated data direction register bit is set to 0.

If the data direction register bits are set to 1, the contents of the data register is returned. This is independent of any other configuration (Figure 2-64).

2.5.2.2 Input Register (PTIx)

This register is read-only and always returns the buffered state of the pin (Figure 2-64).

8.4.6 Tagging

A tag follows program information as it advances through the instruction queue. When a tagged instruction reaches the head of the queue a tag hit occurs and can initiate a state sequencer transition.

Each comparator control register features a TAG bit, which controls whether the comparator match causes a state sequencer transition immediately or tags the opcode at the matched address. If a comparator is enabled for tagged comparisons, the address stored in the comparator match address registers must be an opcode address.

Using Begin trigger together with tagging, if the tagged instruction is about to be executed then the transition to the next state sequencer state occurs. If the transition is to the Final State, tracing is started. Only upon completion of the tracing session can a breakpoint be generated. Using End alignment, when the tagged instruction is about to be executed and the next transition is to Final State then a breakpoint is generated immediately, before the tagged instruction is carried out.

R/W monitoring, access size (SZ) monitoring and data bus monitoring are not useful if tagging is selected, since the tag is attached to the opcode at the matched address and is not dependent on the data bus nor on the type of access. Thus these bits are ignored if tagging is selected.

When configured for range comparisons and tagging, the ranges are accurate only to word boundaries.

Tagging is disabled when the BDM becomes active.

8.4.7 Breakpoints

It is possible to generate breakpoints from channel transitions to final state or using software to write to the TRIG bit in the DBGC1 register.

8.4.7.1 Breakpoints From Comparator Channels

Breakpoints can be generated when the state sequencer transitions to the Final State. If configured for tagging, then the breakpoint is generated when the tagged opcode reaches the execution stage of the instruction queue.

If a tracing session is selected by the TSOURCE bit, breakpoints are requested when the tracing session has completed, thus if Begin aligned triggering is selected, the breakpoint is requested only on completion of the subsequent trace (see Table 8-42). If no tracing session is selected, breakpoints are requested immediately.

If the BRK bit is set, then the associated breakpoint is generated immediately independent of tracing trigger alignment.

Table 8-42. Breakpoint Setup For CPU Breakpoints

BRK	TALIGN	DBGBRK	Breakpoint Alignment
0	0	0	Fill Trace Buffer until trigger then disarm (no breakpoints)
0	0	1	Fill Trace Buffer until trigger, then breakpoint request occurs
0	1	0	Start Trace Buffer at trigger (no breakpoints)

Table 12-13. Sample Time Select

SMP2	SMP1	SMP0	Sample Time in Number of ATD Clock Cycles
1	1	1	24

12.3.2.6 ATD Control Register 5 (ATDCTL5)

Writes to this register will abort current conversion sequence and start a new conversion sequence. If the external trigger function is enabled (ETRIGE=1) an initial write to ATDCTL5 is required to allow starting of a conversion sequence which will then occur on each trigger event. Start of conversion means the beginning of the sampling phase.

Module Base + 0x0005

	7	6	5	4	3	2	1	0
R	0	SC	SCAN	MULT	CD	CC	CB	CA
W								
Reset	0	0	0	0	0	0	0	0

= Unimplemented or Reserved

Figure 12-8. ATD Control Register 5 (ATDCTL5)

Read: Anytime

Write: Anytime

Table 12-14. ATDCTL5 Field Descriptions

Field	Description
6 SC	**Special Channel Conversion Bit** — If this bit is set, then special channel conversion can be selected using CD, CC, CB and CA of ATDCTL5. Table 12-15 lists the coding. 0 Special channel conversions disabled 1 Special channel conversions enabled
5 SCAN	**Continuous Conversion Sequence Mode** — This bit selects whether conversion sequences are performed continuously or only once. If the external trigger function is enabled (ETRIGE=1) setting this bit has no effect, thus the external trigger always starts a single conversion sequence. 0 Single conversion sequence 1 Continuous conversion sequences (scan mode)

16.3.2.10 ATD Input Enable Register (ATDDIEN)

Module Base + 0x000C

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R W	IEN[15:0]															
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

= Unimplemented or Reserved

Figure 16-12. ATD Input Enable Register (ATDDIEN)

Read: Anytime

Write: Anytime

Table 16-19. ATDDIEN Field Descriptions

Field	Description
15–0 IEN[15:0]	**ATD Digital Input Enable on channel *x* (*x*= 15, 14, 13, 12, 11, 10, 9, 8, 7, 6, 5, 4, 3, 2, 1, 0)** — This bit controls the digital input buffer from the analog input pin (AN*x*) to the digital data register. 0 Disable digital input buffer to AN*x* pin 1 Enable digital input buffer on AN*x* pin. **Note:** Setting this bit will enable the corresponding digital input buffer continuously. If this bit is set while simultaneously using it as an analog port, there is potentially increased power consumption because the digital input buffer maybe in the linear region.

16.3.2.11 ATD Compare Higher Than Register (ATDCMPHT)

Writes to this register will abort current conversion sequence.

Read: Anytime

Write: Anytime

Module Base + 0x000E

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
R W	CMPHT[15:0]															
Reset	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

= Unimplemented or Reserved

Figure 16-13. ATD Compare Higher Than Register (ATDCMPHT)

Table 16-20. ATDCMPHT Field Descriptions

Field	Description
15–0 CMPHT[15:0]	**Compare Operation Higher Than Enable for conversion number *n* (*n*= 15, 14, 13, 12, 11, 10, 9, 8, 7, 6, 5, 4, 3, 2, 1, 0) of a Sequence (*n conversion number, NOT channel number!)*** — This bit selects the operator for comparison of conversion results. 0 If result of conversion *n* is **lower or same than** compare value in ATDDR*n*, this is flagged in ATDSTAT2 1 If result of conversion *n* is **higher than** compare value in ATDDR*n*, this is flagged in ATDSTAT2

Table 20-11. SCISR1 Field Descriptions (continued)

Field	Description
1 FE	**Framing Error Flag** — FE is set when a logic 0 is accepted as the stop bit. FE bit is set during the same cycle as the RDRF flag but does not get set in the case of an overrun. FE inhibits further data reception until it is cleared. Clear FE by reading SCI status register 1 (SCISR1) with FE set and then reading the SCI data register low (SCIDRL). 0 No framing error 1 Framing error
0 PF	**Parity Error Flag** — PF is set when the parity enable bit (PE) is set and the parity of the received data does not match the parity type bit (PT). PF bit is set during the same cycle as the RDRF flag but does not get set in the case of an overrun. Clear PF by reading SCI status register 1 (SCISR1), and then reading SCI data register low (SCIDRL). 0 No parity error 1 Parity error

20.3.2.8 SCI Status Register 2 (SCISR2)

Module Base + 0x0005

	7	6	5	4	3	2	1	0
R	AMAP	0	0	TXPOL	RXPOL	BRK13	TXDIR	RAF
W								
Reset	0	0	0	0	0	0	0	0

= Unimplemented or Reserved

Figure 20-11. SCI Status Register 2 (SCISR2)

Read: Anytime

Write: Anytime

Table 20-12. SCISR2 Field Descriptions

Field	Description
7 AMAP	**Alternative Map** — This bit controls which registers sharing the same address space are accessible. In the reset condition the SCI behaves as previous versions. Setting AMAP=1 allows the access to another set of control and status registers and hides the baud rate and SCI control Register 1. 0 The registers labelled SCIBDH (0x0000),SCIBDL (0x0001), SCICR1 (0x0002) are accessible 1 The registers labelled SCIASR1 (0x0000),SCIACR1 (0x0001), SCIACR2 (0x00002) are accessible
4 TXPOL	**Transmit Polarity** — This bit control the polarity of the transmitted data. In NRZ format, a one is represented by a mark and a zero is represented by a space for normal polarity, and the opposite for inverted polarity. In IrDA format, a zero is represented by short high pulse in the middle of a bit time remaining idle low for a one for normal polarity, and a zero is represented by short low pulse in the middle of a bit time remaining idle high for a one for inverted polarity. 0 Normal polarity 1 Inverted polarity

The main element of the SPI system is the SPI data register. The n-bit[1] data register in the master and the n-bit[1] data register in the slave are linked by the MOSI and MISO pins to form a distributed 2n-bit[1] register. When a data transfer operation is performed, this 2n-bit[1] register is serially shifted n[1] bit positions by the S-clock from the master, so data is exchanged between the master and the slave. Data written to the master SPI data register becomes the output data for the slave, and data read from the master SPI data register after a transfer operation is the input data from the slave.

A read of SPISR with SPTEF = 1 followed by a write to SPIDR puts data into the transmit data register. When a transfer is complete and SPIF is cleared, received data is moved into the receive data register. This data register acts as the SPI receive data register for reads and as the SPI transmit data register for writes. A common SPI data register address is shared for reading data from the read data buffer and for writing data to the transmit data register.

The clock phase control bit (CPHA) and a clock polarity control bit (CPOL) in the SPI control register 1 (SPICR1) select one of four possible clock formats to be used by the SPI system. The CPOL bit simply selects a non-inverted or inverted clock. The CPHA bit is used to accommodate two fundamentally different protocols by sampling data on odd numbered SCK edges or on even numbered SCK edges (see Section 21.4.3, “Transmission Formats”).

The SPI can be configured to operate as a master or as a slave. When the MSTR bit in SPI control register1 is set, master mode is selected, when the MSTR bit is clear, slave mode is selected.

NOTE

A change of CPOL or MSTR bit while there is a received byte pending in the receive shift register will destroy the received byte and must be avoided.

21.4.1 Master Mode

The SPI operates in master mode when the MSTR bit is set. Only a master SPI module can initiate transmissions. A transmission begins by writing to the master SPI data register. If the shift register is empty, data immediately transfers to the shift register. Data begins shifting out on the MOSI pin under the control of the serial clock.

- Serial clock

  The SPR2, SPR1, and SPR0 baud rate selection bits, in conjunction with the SPPR2, SPPR1, and SPPR0 baud rate preselection bits in the SPI baud rate register, control the baud rate generator and determine the speed of the transmission. The SCK pin is the SPI clock output. Through the SCK pin, the baud rate generator of the master controls the shift register of the slave peripheral.
- MOSI, MISO pin

  In master mode, the function of the serial data output pin (MOSI) and the serial data input pin (MISO) is determined by the SPC0 and BIDIROE control bits.
- $\overline{SS}$ pin

  If MODFEN and SSOE are set, the $\overline{SS}$ pin is configured as slave select output. The $\overline{SS}$ output becomes low during each transmission and is high when the SPI is in idle state.

1. n depends on the selected transfer width, please refer to Section 21.3.2.2, “SPI Control Register 2 (SPICR2)

Chapter 22
Timer Module (TIM16B6CV3)

Table 22-1. Revision History

V03.00	Jan. 28, 2009		Initial version
V03.01	Aug. 26, 2009	22.1.2/22-720 22.3.2.2/22-723, 22.4.3/22-735	- Correct typo: TSCR ->TSCR1; - Correct typo: ECTxxx->TIMxxx - Add description, “a counter overflow when TTOV[7] is set”, to be the condition of channel 7 override event. - Phrase the description of OC7M to make it more explicit
V03.02	Apri,12,2010	22.3.2.6/22-726 22.3.2.9/22-728 22.4.3/22-735	-update TCRE bit description
V03.03	Jan,14,2013		-single source generate different channel guide

22.1 Introduction

The basic scalable timer consists of a 16-bit, software-programmable counter driven by a flexible programmable prescaler.

This timer can be used for many purposes, including input waveform measurements while simultaneously generating an output waveform.

This timer could contain up to 6 input capture/output compare channels . The input capture function is used to detect a selected transition edge and record the time. The output compare function is used for generating output signals or for timer software delays.

A full access for the counter registers or the input capture/output compare registers should take place in one clock cycle. Accessing high byte and low byte separately for all of these registers may not yield the same result as accessing them in one word.

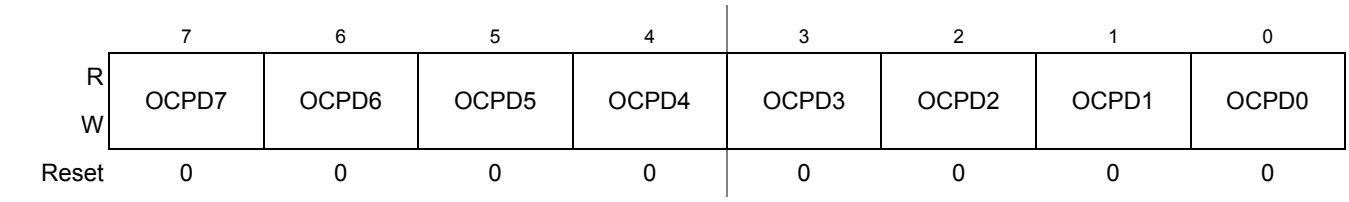
22.1.1 Features

The TIM16B6CV3 includes these distinctive features:

- Up to 6 channels available. (refer to device specification for exact number)
- All channels have same input capture/output compare functionality.
- Clock prescaling.
- 16-bit counter.

23.3.2.18 Output Compare Pin Disconnect Register(OCPD)

Module Base + 0x002C



	7	6	5	4	3	2	1	0
R W	OCPD7	OCPD6	OCPD5	OCPD4	OCPD3	OCPD2	OCPD1	OCPD0
Reset	0	0	0	0	0	0	0	0

Figure 23-28. Output Compare Pin Disconnect Register (OCPD)

Read: Anytime

Write: Anytime

All bits reset to zero.

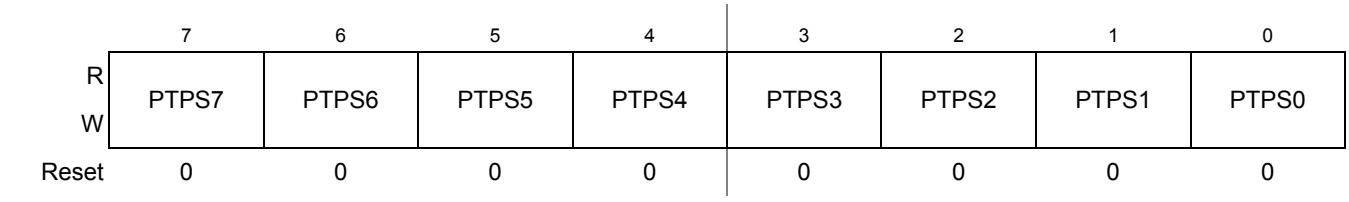
Table 23-22. OCPD Field Description

Note: Writing to unavailable bits has no effect. Reading from unavailable bits return a zero.

Field	Description
7:0 OCPD[7:0]	Output Compare Pin Disconnect Bits 0 Enables the timer channel port. Output Compare action will occur on the channel pin. These bits do not affect the input capture or pulse accumulator functions. 1 Disables the timer channel port. Output Compare action will not occur on the channel pin, but the output compare flag still become set.

23.3.2.19 Precision Timer Prescaler Select Register (PTPSR)

Module Base + 0x002E



	7	6	5	4	3	2	1	0
R W	PTPS7	PTPS6	PTPS5	PTPS4	PTPS3	PTPS2	PTPS1	PTPS0
Reset	0	0	0	0	0	0	0	0

Figure 23-29. Precision Timer Prescaler Select Register (PTPSR)

Read: Anytime

Write: Anytime

All bits reset to zero.

Table 24-15. FSTAT Field Descriptions

Field	Description
7 CCIF	**Command Complete Interrupt Flag** — The CCIF flag indicates that a Flash command has completed. The CCIF flag is cleared by writing a 1 to CCIF to launch a command and CCIF will stay low until command completion or command violation. 0 Flash command in progress 1 Flash command has completed
5 ACCERR	**Flash Access Error Flag** — The ACCERR bit indicates an illegal access has occurred to the Flash memory caused by either a violation of the command write sequence (see Section 24.4.4.2) or issuing an illegal Flash command. While ACCERR is set, the CCIF flag cannot be cleared to launch a command. The ACCERR bit is cleared by writing a 1 to ACCERR. Writing a 0 to the ACCERR bit has no effect on ACCERR. 0 No access error detected 1 Access error detected
4 FPVIOL	**Flash Protection Violation Flag** —The FPVIOL bit indicates an attempt was made to program or erase an address in a protected area of P-Flash or EEPROM memory during a command write sequence. The FPVIOL bit is cleared by writing a 1 to FPVIOL. Writing a 0 to the FPVIOL bit has no effect on FPVIOL. While FPVIOL is set, it is not possible to launch a command or start a command write sequence. 0 No protection violation detected 1 Protection violation detected
3 MGBUSY	**Memory Controller Busy Flag** — The MGBUSY flag reflects the active state of the Memory Controller. 0 Memory Controller is idle 1 Memory Controller is busy executing a Flash command (CCIF = 0)
2 RSVD	**Reserved Bit** — This bit is reserved and always reads 0.
1–0 MGSTAT[1:0]	**Memory Controller Command Completion Status Flag** — One or more MGSTAT flag bits are set if an error is detected during execution of a Flash command or during the Flash reset sequence. See Section 24.4.6, “Flash Command Description,” and Section 24.6, “Initialization” for details.

24.3.2.8 Flash Error Status Register (FERSTAT)

The FERSTAT register reflects the error status of internal Flash operations.

Offset Module Base + 0x0007

	7	6	5	4	3	2	1	0
R	0	0	0	0	0	0	DFDIF	SFDIF
W								
Reset	0	0	0	0	0	0	0	0

= Unimplemented or Reserved

Figure 24-12. Flash Error Status Register (FERSTAT)

All flags in the FERSTAT register are readable and only writable to clear the flag.

Table 26-4. Flash Configuration Field

Global Address	Size (Bytes)	Description
0x3_FF00-0x3_FF07	8	Backdoor Comparison Key Refer to Section 26.4.6.11, “Verify Backdoor Access Key Command,” and Section 26.5.1, “Unsecuring the MCU using Backdoor Key Access”
0x3_FF08-0x3_FF0B[1]	4	Reserved
0x3_FF0C[1]	1	P-Flash Protection byte. Refer to Section 26.3.2.9, “P-Flash Protection Register (FPROT)”
0x3_FF0D[1]	1	EEPROM Protection byte. Refer to Section 26.3.2.10, “EEPROM Protection Register (EEPROT)”
0x3_FF0E[1]	1	Flash Nonvolatile byte Refer to Section 26.3.2.16, “Flash Option Register (FOPT)”
0x3_FF0F[1]	1	Flash Security byte Refer to Section 26.3.2.2, “Flash Security Register (FSEC)”

1 0x3FF08-0x3_FF0F form a Flash phrase and must be programmed in a single command write sequence. Each byte in the 0x3_FF08 - 0x3_FF0B reserved field should be programmed to 0xFF.

Table 26-63. Program EEPROM Command Error Handling

Register	Error Bit	Error Condition
FSTAT	ACCERR	Set if CCOBIX[2:0] < 010 at command launch
		Set if CCOBIX[2:0] > 101 at command launch
		Set if command not available in current mode (see Table 26-27)
		Set if an invalid global address [17:0] is supplied
		Set if a misaligned word address is supplied (global address [0] != 0)
		Set if the requested group of words breaches the end of the EEPROM block
	FPVIOL	Set if the selected area of the EEPROM memory is protected
	MGSTAT1	Set if any errors have been encountered during the verify operation
	MGSTAT0	Set if any non-correctable errors have been encountered during the verify operation

26.4.6.16 Erase EEPROM Sector Command

The Erase EEPROM Sector operation will erase all addresses in a sector of the EEPROM block.

Table 26-64. Erase EEPROM Sector Command FCCOB Requirements

CCOBIX[2:0]	FCCOB Parameters	
000	0x12	Global address [17:16] to identify EEPROM block
001	Global address [15:0] anywhere within the sector to be erased. See Section 26.1.2.2 for EEPROM sector size.	

Upon clearing CCIF to launch the Erase EEPROM Sector command, the Memory Controller will erase the selected Flash sector and verify that it is erased. The CCIF flag will set after the Erase EEPROM Sector operation has completed.

Table 26-65. Erase EEPROM Sector Command Error Handling

Register	Error Bit	Error Condition
FSTAT	ACCERR	Set if CCOBIX[2:0] != 001 at command launch
		Set if command not available in current mode (see Table 26-27)
		Set if an invalid global address [17:0] is suppliedsee Table 26-3)
		Set if a misaligned word address is supplied (global address [0] != 0)
	FPVIOL	Set if the selected area of the EEPROM memory is protected
	MGSTAT1	Set if any errors have been encountered during the verify operation
	MGSTAT0	Set if any non-correctable errors have been encountered during the verify operation

Upon clearing CCIF to launch the Read Once command, a Read Once phrase is fetched and stored in the FCCOB indexed register. The CCIF flag will set after the Read Once operation has completed. Valid phrase index values for the Read Once command range from 0x0000 to 0x0007. During execution of the Read Once command, any attempt to read addresses within P-Flash block will return invalid data.

Table 31-39. Read Once Command Error Handling

Register	Error Bit	Error Condition
FSTAT	ACCERR	Set if CCOBIX[2:0] != 001 at command launch
		Set if command not available in current mode (see Table 31-27)
		Set if an invalid phrase index is supplied
	FPVIOL	None
	MGSTAT1	Set if any errors have been encountered during the read
	MGSTAT0	Set if any non-correctable errors have been encountered during the read

31.4.6.5 Program P-Flash Command

The Program P-Flash operation will program a previously erased phrase in the P-Flash memory using an embedded algorithm.

CAUTION

A P-Flash phrase must be in the erased state before being programmed. Cumulative programming of bits within a Flash phrase is not allowed.

Table 31-40. Program P-Flash Command FCCOB Requirements

CCOBIX[2:0]	FCCOB Parameters	
000	0x06	Global address [17:16] to identify P-Flash block
001	Global address [15:0] of phrase location to be programmed[1]	
010	Word 0 program value	
011	Word 1 program value	
100	Word 2 program value	
101	Word 3 program value	

[1] Global address [2:0] must be 000

Upon clearing CCIF to launch the Program P-Flash command, the Memory Controller will program the data words to the supplied global address and will then proceed to verify the data words read back as expected. The CCIF flag will set after the Program P-Flash operation has completed.

CAUTION

Field margin levels must only be used during verify of the initial factory programming.

NOTE

Field margin levels can be used to check that Flash memory contents have adequate margin for data retention at the normal level setting. If unexpected results are encountered when checking Flash memory contents at field margin levels, the Flash memory contents should be erased and reprogrammed.

31.4.6.14 Erase Verify EEPROM Section Command

The Erase Verify EEPROM Section command will verify that a section of code in the EEPROM is erased. The Erase Verify EEPROM Section command defines the starting point of the data to be verified and the number of words.

Table 31-60. Erase Verify EEPROM Section Command FCCOB Requirements

CCOBIX[2:0]	FCCOB Parameters	
000	0x10	Global address [17:16] to identify the EEPROM block
001	Global address [15:0] of the first word to be verified	
010	Number of words to be verified	

Upon clearing CCIF to launch the Erase Verify EEPROM Section command, the Memory Controller will verify the selected section of EEPROM memory is erased. The CCIF flag will set after the Erase Verify EEPROM Section operation has completed. If the section is not erased, it means blank check failed, both MGSTAT bits will be set.

Table 31-61. Erase Verify EEPROM Section Command Error Handling

Register	Error Bit	Error Condition
FSTAT	ACCERR	Set if CCOBIX[2:0] != 010 at command launch
		Set if command not available in current mode (see Table 31-27)
		Set if an invalid global address [17:0] is supplied
		Set if a misaligned word address is supplied (global address [0] != 0)
		Set if the requested section breaches the end of the EEPROM block
	FPVIOL	None
	MGSTAT1	Set if any errors have been encountered during the read or if blank check failed.
	MGSTAT0	Set if any non-correctable errors have been encountered during the read or if blank check failed.

Table A-18. Pseudo Stop Current Characteristics

Conditions are: V_{DDX}=5V, V_{DDR}=5V, V_{DDA}=5V, RTI and COP and API enabled, see Table A-12.							
Num	**C**	**Rating**	**Symbol**	**Min**	**Typ**	**Max**	**Unit**
S12GN16, S12GN32							
1	C	-40°C	I_{DDPS}		155		µA
2	C	25°C	I_{DDPS}		165		µA
3	C	150°C	I_{DDPS}		265		µA
4	C	160°C	I_{DDPS}		295		µA
S12GN48, S12G48, S12G64							
5	C	-40°C	I_{DDPS}		160		µA
6	C	25°C	I_{DDPS}		170		µA
7	C	150°C	I_{DDPS}		285		µA
S12G96, S12G128							
8	C	-40°C	I_{DDPS}		165		µA
9	C	25°C	I_{DDPS}		175		µA
10	C	150°C	I_{DDPS}		320		µA
S12G192, S12GA192, S12G240, S12GA240							
11	C	-40°C	I_{DDPS}		175		µA
12	C	25°C	I_{DDPS}		185		µA
13	C	150°C	I_{DDPS}		430		µA

A.4 ADC Characteristics

This section describes the characteristics of the analog-to-digital converter.

A.4.1 ADC Operating Characteristics

The Table A-19 and Table A-20 show conditions under which the ADC operates.

The following constraints exist to obtain full-scale, full range results:

$$V_{SSA} \le V_{RL} \le V_{IN} \le V_{RH} \le V_{DDA}.$$